

isc N-Channel MOSFET Transistor

AOB290L

• FEATURES

- With TO-263(D2PAK) packaging
- High speed switching
- Low gate input resistance
- Standard level gate drive
- Easy to use
- 100% avalanche tested
- Minimum Lot-to-Lot variations for robust device performance and reliable operation

• APPLICATIONS

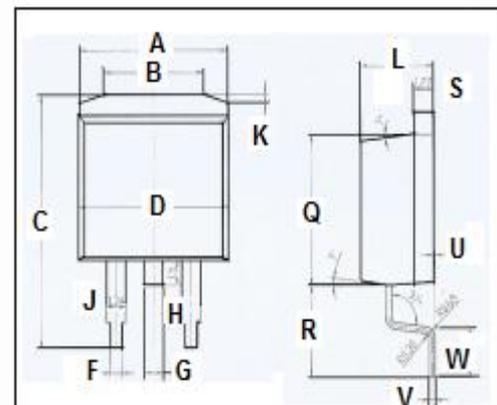
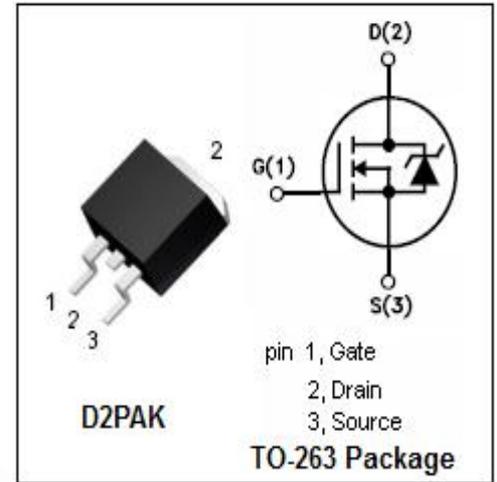
- Power supply
- Switching applications

• ABSOLUTE MAXIMUM RATINGS(T_a=25°C)

| SYMBOL | PARAMETER | VALUE | UNIT |
|------------------|--|------------|------|
| V _{DSS} | Drain-Source Voltage | 650 | V |
| V _{GSS} | Gate-Source Voltage | ±25 | V |
| I _D | Drain Current-Continuous@T _c =25°C T _c =100°C | 42 26.5 | A |
| I _{DM} | Drain Current-Single Pulsed | 168 | A |
| P _D | Total Dissipation | 250 | W |
| T _j | Operating Junction Temperature | 150 | °C |
| T _{stg} | Storage Temperature | -55~150 | °C |

• THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | MAX | UNIT |
|-----------------------|---------------------------------------|------|------|
| R _{th(ch-c)} | Channel-to-case thermal resistance | 0.5 | °C/W |
| R _{th(ch-a)} | Channel-to-ambient thermal resistance | 62.5 | °C/W |



| DIM | mm | |
|-----|-------|-------|
| | MIN | MAX |
| A | 10 | |
| B | 6.6 | 6.8 |
| C | 15.23 | 15.25 |
| D | 10.15 | 10.17 |
| F | 0.76 | 0.78 |
| G | 1.26 | 1.28 |
| H | 1.4 | 1.6 |
| J | 1.33 | 1.35 |
| K | 0.4 | 0.6 |
| L | 4.6 | 4.8 |
| O | 8.69 | 8.71 |
| R | 5.28 | 5.30 |
| S | 1.26 | 1.28 |
| U | 0.0 | 0.2 |
| V | 0.37 | 0.39 |
| W | 2.80 | 2.82 |

isc N-Channel MOSFET Transistor

AOB290L

ELECTRICAL CHARACTERISTICS

T_C=25°C unless otherwise specified

| SYMBOL | PARAMETER | CONDITIONS | MIN | TYP | MAX | UNIT |
|---------------------|--------------------------------|---|-----|-----|----------|------|
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V; I _D = 1mA | 650 | | | V |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} =V _{GS} V; I _D =0.25mA | 3 | | 5 | V |
| R _{DS(on)} | Drain-Source On-Resistance | V _{GS} = 10V; I _D =21A | | 56 | 63 | mΩ |
| I _{GSS} | Gate-Source Leakage Current | V _{GS} = ±25V; V _{DS} = 0V | | | ±0.1 | μA |
| I _{DSS} | Drain-Source Leakage Current | V _{DS} = 650V; V _{GS} = 0V; T _J =25°C T _J =125°C | | | 1 100 | μA |
| V _{SDF} | Diode forward voltage | I _{SD} =42A, V _{GS} = 0 V | | | 1.5 | V |